Supporting Information

for

Optimization of Mo/Cr bilayer back contacts for thin-film solar cells

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Additional experimental data

Summary of adhesion test results

Substrate	Power (W)	Pressure (mTorr)	Adhesion Test
Uncoated	100	10	Failed
Uncoated	150	10	Failed
Uncoated	200	10	Failed
Uncoated	100	5	Failed
Uncoated	150	5	Failed
Uncoated	200	5	Failed
Uncoated	100	3	Failed
Uncoated	150	3	Failed
Uncoated	200	3	Failed
Coated	100	10	Pass
Coated	150	10	Pass
Coated	200	10	Pass
Coated	100	5	Pass
Coated	150	5	Pass
Coated	200	5	Pass
Coated	100	3	Pass
Coated	150	3	Pass
Coated	200	3	Pass

Table S1: Adhesion test performed on 600 nm thick Mo layers, sputtered at different power and pressure on uncoated and Cr-coated substrates. Cr thickness is 10–15 nm.

Surface AFM images of Mo/Cr films



Figure S1: Surface AFM images of Mo/Cr films prepared at sputtering power and pressure of (a) 100 W, 3 mTorr, (b) 100 W, 5 mTorr, (c) 150 W, 3 mTorr, (d) 150 W, 5 mTorr, (e) 200 W, 3 mTorr, (f) 200 W, 5 mTorr.

High-resolution XPS measurements



Figure S2: High-resolution XPS scans of Mo 3d and Cr 2p at the Mo/Cr interface.